GE85T08

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BV_{DSS}	80V
$R_{DS(ON)}$	13mΩ
I_D	75A

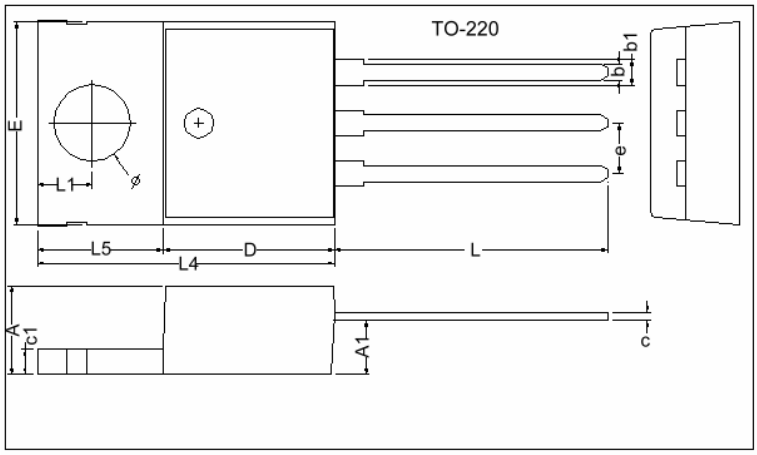
Description

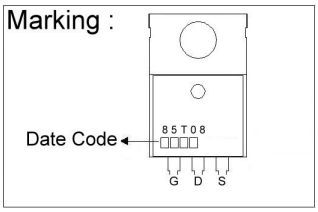
The GE85T08 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.
The through-hole version (TO-220) is available for low-profile applications and suited for low voltage applications such as DC/DC converters.

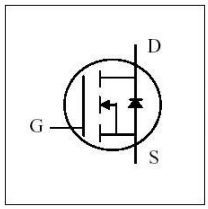
Features

*Simple Drive Requirement
*Lower On-resistance
*Fast Switching

Package Dimensions







REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.40	4.80	c1	1.25	1.45
b	0.76	1.00	b1	1.17	1.47
c	0.36	0.50	L	13.25	14.25
D	8.60	9.00	e	2.54 REF.	
E	9.80	10.4	L1	2.60	2.89
L4	14.7	15.3	Ø	3.71	3.96
L5	6.20	6.60	A1	2.60	2.80

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current, V_{GS}@10V	I_D @Tc=25℃	75	A
Continuous Drain Current, V_{GS}@10V	I_D @Tc=100℃	48	A
Pulsed Drain Current[1]	I_{DM}	260	A
Total Power Dissipation	P_D @Tc=25℃	138	W
Linear Derating Factor		1.11	W/℃
Single Pulse Avalanche Energy[3]	E_{AS}	450	mJ
Avalanche Current	I_{AR}	30	A
Operating Junction and Storage Temperature Range	Tj, Tstg	-55 ~ +150	℃

Thermal Data

Parameter		Symbol	Value	Unit
Thermal Resistance Junction-case	Max.	Rthj-c	0.9	℃/W
Thermal Resistance Junction-ambient	Max.	Rthj-a	62	℃/W

Electrical Characteristics(Tj = 25℃ Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	80	-	-	V	V_{GS}=0, I_D=1mA
Breakdown Voltage Temperature Coefficient	$\triangle BV_{DSS}/\triangle Tj$	-	0.09	-	V/℃	Reference to 25℃, I_D=1mA
Gate Threshold Voltage	$V_{GS(th)}$	1.0	-	3.0	V	V_{DS}=V_{GS}, I_D=250uA
Forward Transconductance	g_{fs}	-	70	-	S	V_{DS}=10V, I_D=45A
Gate-Source Leakage Current	I_{GSS}	-	-	±100	nA	V_{GS}= ±20V
Drain-Source Leakage Current(Tj=25℃)	I_{DSS}	-	-	10	uA	V_{DS}=80V, V_{GS}=0
Drain-Source Leakage Current(Tj=150℃)		-	-	100	uA	V_{DS}=64V, V_{GS}=0
Static Drain-Source On-Resistance[2]	$R_{DS(ON)}$	-	-	13	mΩ	V_{GS}=10V, I_D=45A
		-	-	18		V_{GS}=4.5V, I_D=25A
Total Gate Charge[2]	Q_g	-	63	100	nC	I_D=45A V_{DS}=64V V_{GS}=4.5V
Gate-Source Charge	Q_{gs}	-	23	-		
Gate-Drain (“Miller”) Change	Q_{gd}	-	38	-		
Turn-on Delay Time[2]	$T_{d(on)}$	-	30	-	ns	V_{DS}=40V I_D=45A V_{GS}=10V R_G=10Ω R_D=0.89Ω
Rise Time	T_r	-	100	-		
Turn-off Delay Time	$T_{d(off)}$	-	144	-		
Fall Time	T_f	-	173	-		
Input Capacitance	C_{iss}	-	6300	10080	pF	V_{GS}=0V V_{DS}=25V f=1.0MHz
Output Capacitance	C_{oss}	-	670	-		
Reverse Transfer Capacitance	C_{rss}	-	350	-		
Gate Resistance	R_g	-	1.1	1.7	Ω	f=1.0MHz

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage[2]	V_{SD}	-	-	1.3	V	I_S=45A, V_{GS}=0V
Reverse Recovery Time[2]	T_{rr}	-	47	-	ns	I_S=20A, V_{GS}=0V dI/dt=100A/μs
Reverse Recovery Charge	Q_{rr}	-	86	-	nC	

Notes: 1. Pulse width limited by safe operating area.

2. Pulse width≦300us, duty cycle≦2%.

3. Staring Tj=25℃, V_{DD}=30V, L=1mH, R_G=25Ω, I_{AS}=30A.

Characteristics Curve

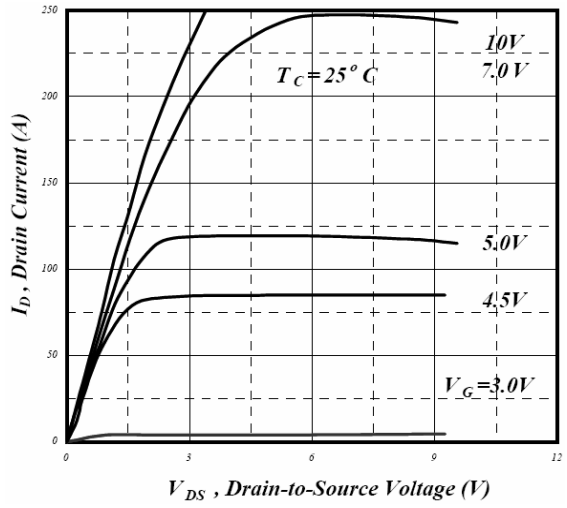


Fig 1. Typical Output Characteristics

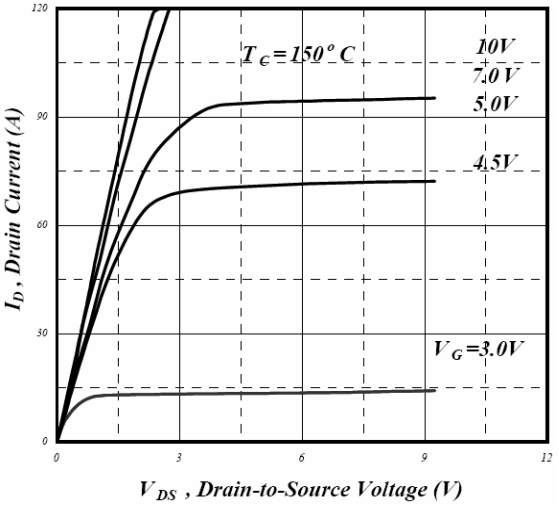


Fig 2. Typical Output Characteristics

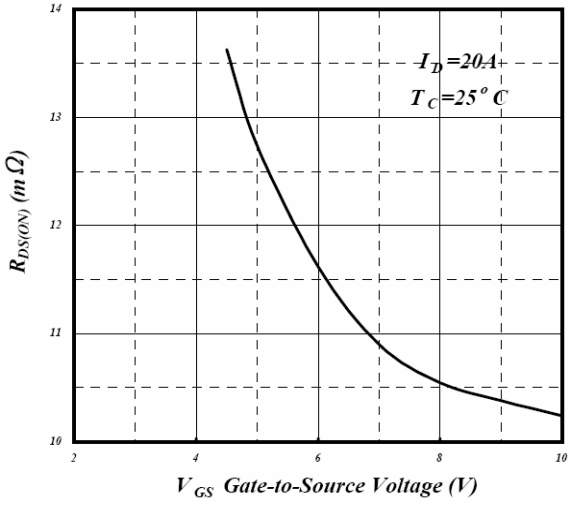


Fig 3. On-Resistance v.s. Gate Voltage

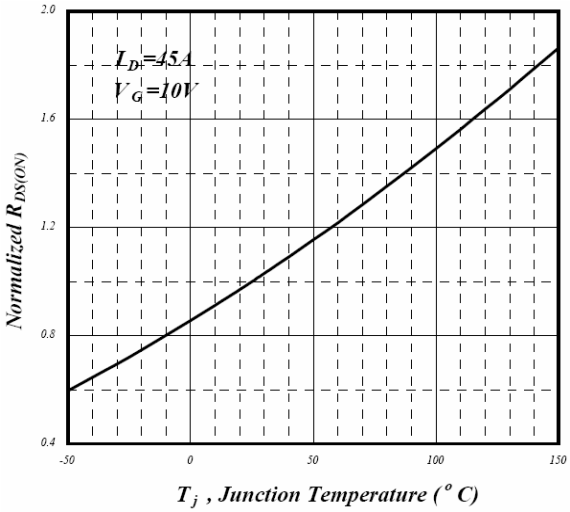


Fig 4. Normalized On-Resistance v.s. Junction Temperature

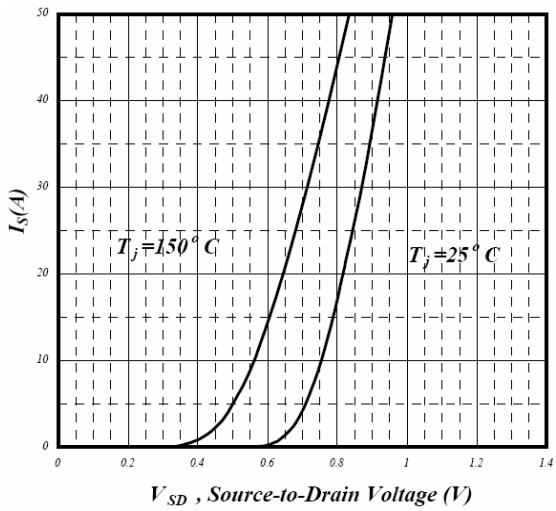


Fig 5. Forward Characteristics of Reverse Diode

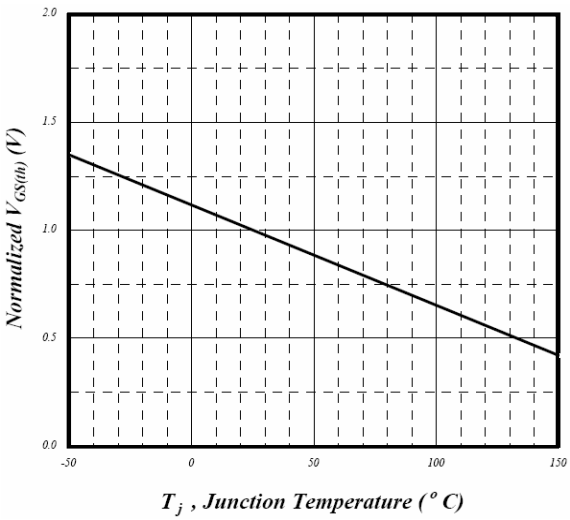


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

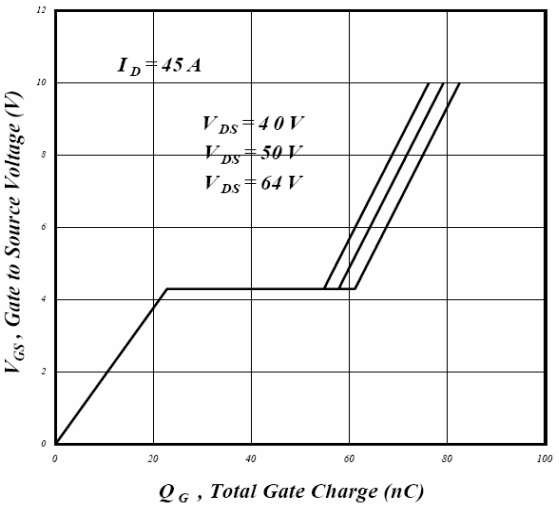


Fig 7. Gate Charge Characteristics

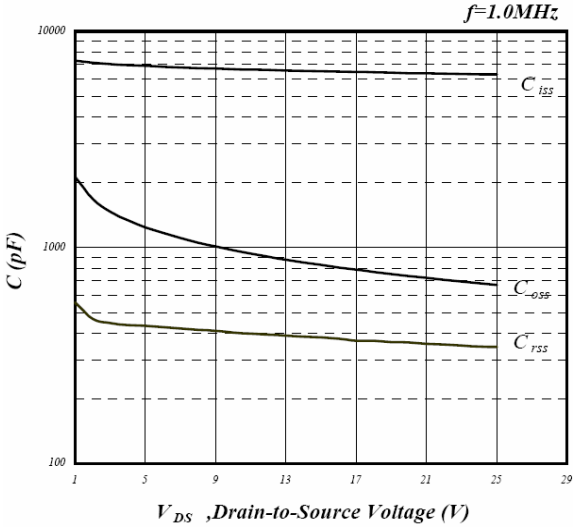


Fig 8. Typical Capacitance Characteristics

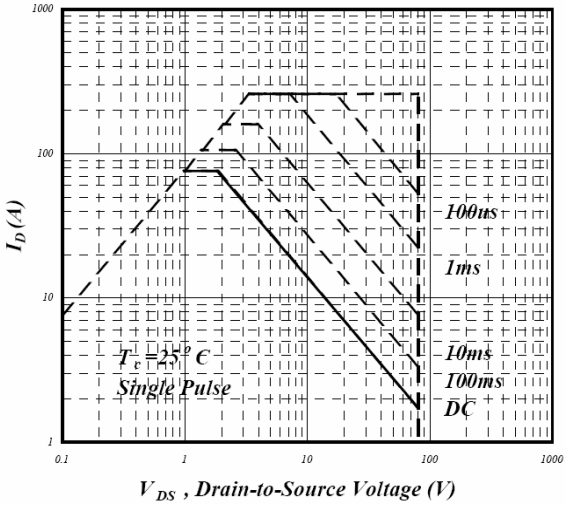


Fig 9. Maximum Safe Operating Area

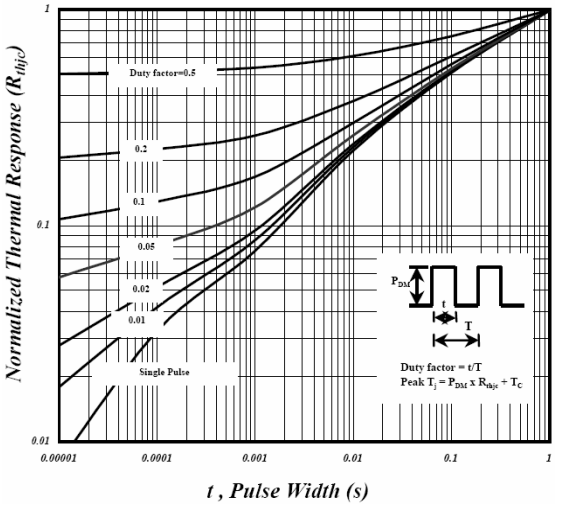


Fig 10. Effective Transient Thermal Impedance

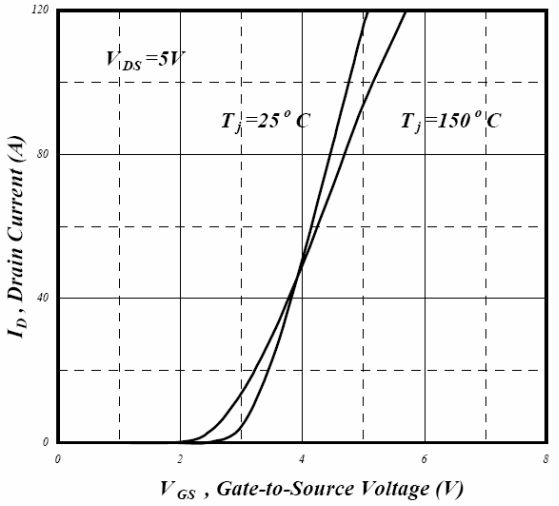


Fig 11. Transfer Characteristics

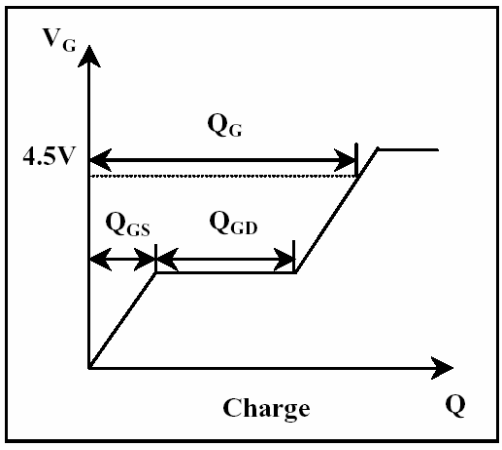


Fig 12. Gate Charge Waveform

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